

FIG. 1

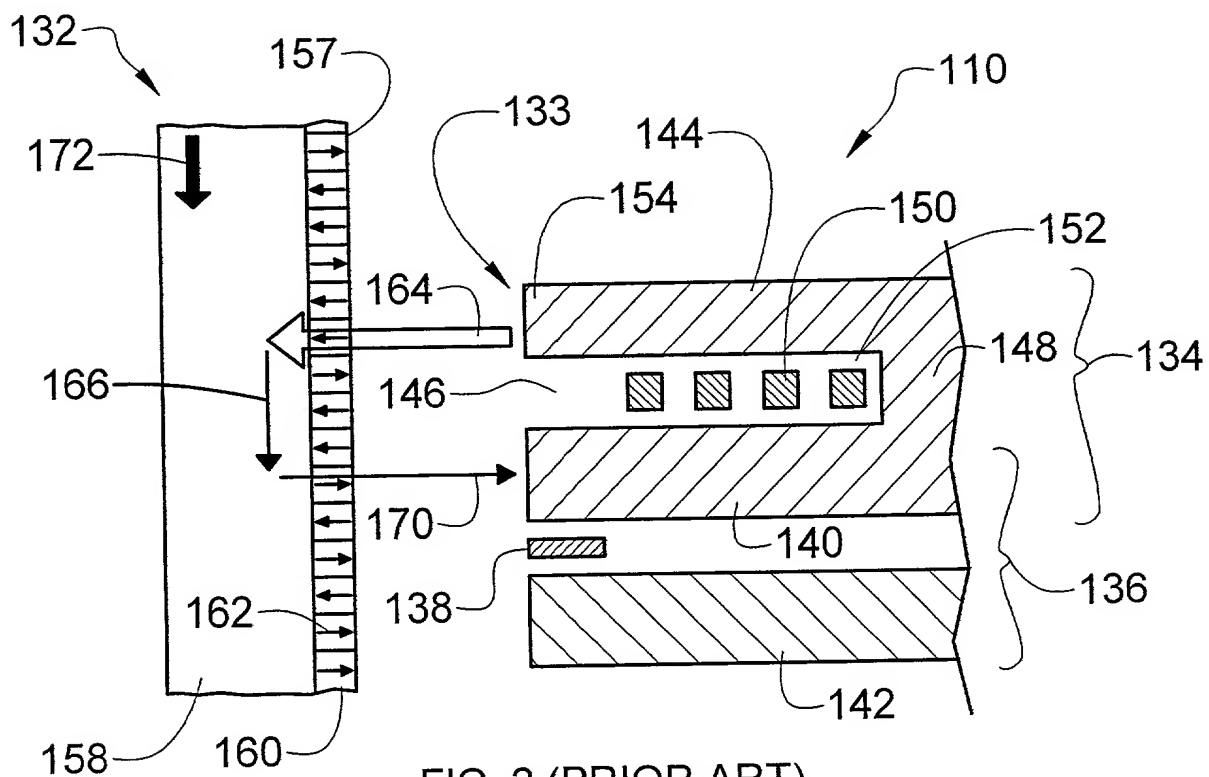


FIG. 2 (PRIOR ART)

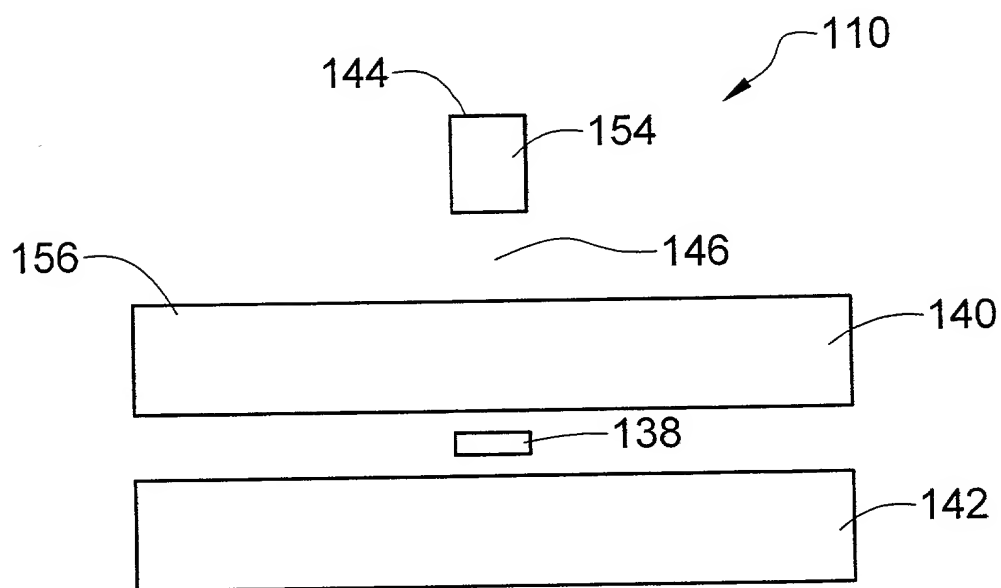


FIG. 3 (PRIOR ART)

A cross-sectional view of a device 218. The device consists of several layers and components. At the top is a layer 188 containing a row of six square features 196. Below this is a horizontal layer 184, which is part of a sub-assembly 182. Underneath layer 184 is another row of six square features 196, with a small rectangular feature 200 located between the first two squares. A layer 194 is positioned below the second row of squares. The bottom section of the device, labeled 216, contains three horizontal layers: a top layer 222, a middle layer 220, and a bottom layer 224. A vertical layer 192 is on the left side of the device. On the far left, a vertical stack of labels 198, 190, 202, and 204 points to the left edge of the device. An arrow 218 points to the top right corner of the device.

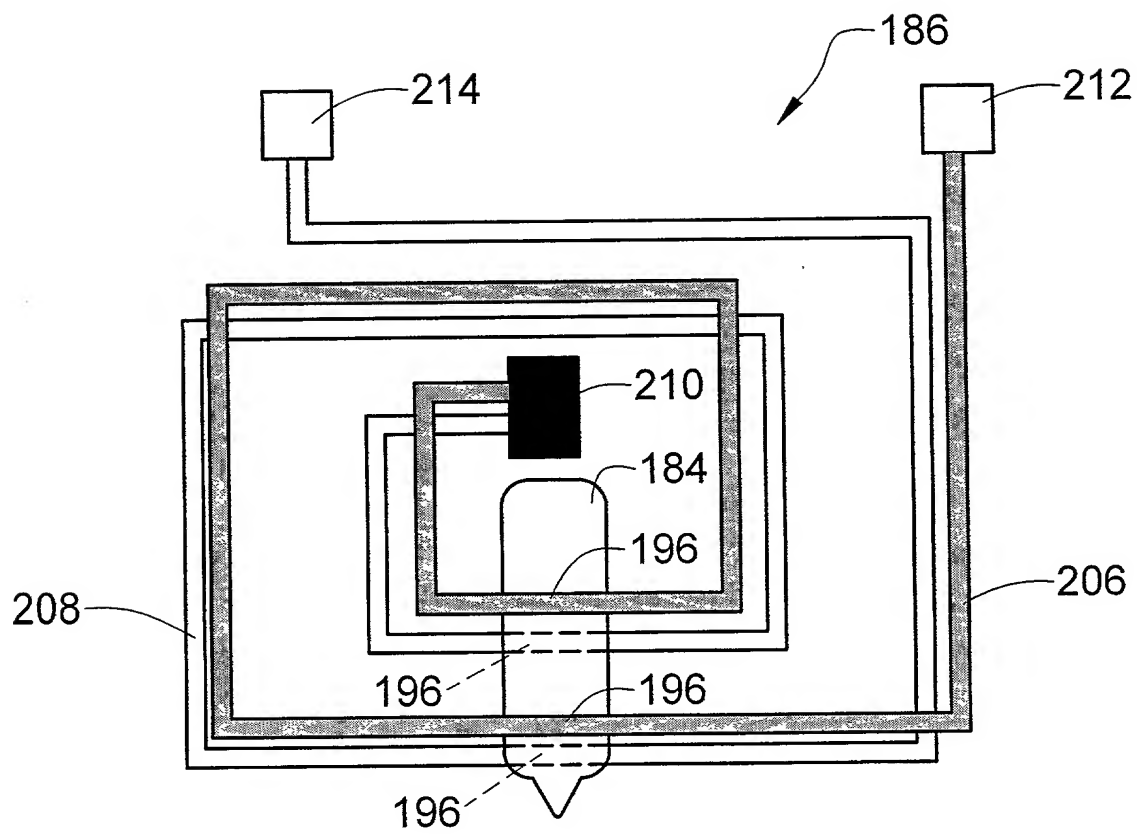


FIG. 6